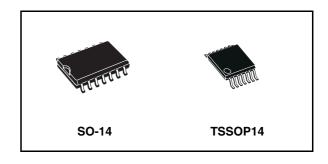


74LCX04

Low voltage CMOS HEX inverter with 5V tolerant inputs

Features

- 5V tolerant inputs
- High speed:
 - t_{PD} = 5.2ns (Max) at V_{CC} = 3V
- Power down protection on inputs and outputs
- Symmetrical output impedance:
 - $II_{OH}I = I_{OL} = 24mA$ (Min) at $V_{CC} = 3V$
- PCI bus levels guaranteed at 24mA
- Balanced propagation delays:
 - t_{PLH} ≅ t_{PHL}
- Operating voltage range:
 - V_{CC} (Opr) = 2.0V to 3.6V
- Pin and function compatible with 74 series 04
- Latch-up performance exceeds 500mA (JESD 17)
- ESD performance:
 - HBM > 2000V (MIL STD 883 method 3015); MM > 200V



Description

The 74LCX04 is a low voltage CMOS HEX inverter fabricated with sub-micron silicon gate and double-layer metal wiring C²MOS technology. It is ideal for low power and high speed 3.3V applications. It can be interfaced to 5V signal environment for inputs.

It has same speed performance at 3.3V than 5V AC/ACT family, combined with a lower power consumption.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

Order codes

Part number	Package	Packaging	
74LCX04MTR	SO-14	Tape and reel	
74LCX04TTR	TSSOP14	Tape and reel	

Contents 74LCX04

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1 Logic symbols and I/O equivalent circuit

Figure 1. IEC logic symbols

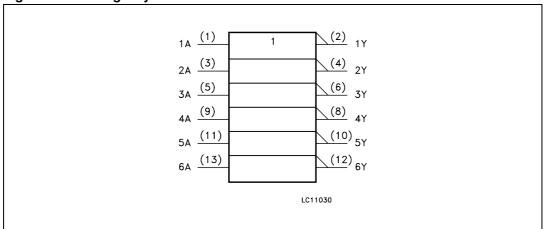
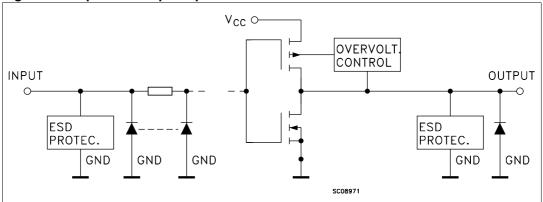


Figure 2. Input and output equivalent circuit



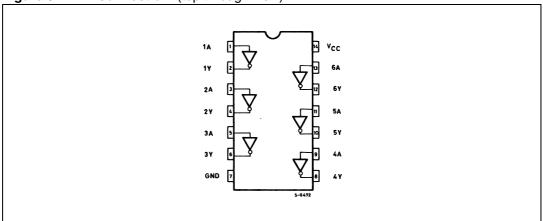
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Pin settings 74LCX04

2 Pin settings

2.1 Pin connection

Figure 3. Pin connection (top through view)



2.2 Pin description

Table 1. Pin description

Pin N°	Symbol	Name and function
1,3,5,9,11,13	1A to 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	data outputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

2.3 Truth table

Table 2. Truth table

Inputs	Output	
Α	Y	
L	Н	
Н	L	

74LCX04 Maximum rating

3 Maximum rating

stressing the device above the rating listed in the "absolute maximum ratings" table may cause permanent damage to the device. these are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. exposure to absolute maximum rating conditions for extended periods may affect device reliability. refer also to the STMicroelectronics sure program and other relevant quality documents.

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _I	DC input voltage	-0.5 to +7.0	V
V _O	DC output voltage (V _{CC} = 0V)	-0.5 to +7.0	V
V _O	DC output voltage (high or low state) (1)	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC input diode current	-50	mA
I _{OK}	DC output diode current ⁽²⁾	-50	mA
Io	DC output current	±50	mA
I _{CC}	DC supply current per supply pin	±100	mA
I _{GND}	DC ground current per supply pin	±100	mA
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec)	300	°C

^{1.} I_{O} absolute maximum rating must be observed

3.1 Recommended operating conditions

Table 4. Recommended operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage (1)	2.0 to 3.6	V
V _I	Input voltage	0 to 5.5	V
Vo	Output voltage (V _{CC} = 0V)	0 to 5.5	V
V _O	Output voltage (high or low state)	0 to V _{CC}	V
I _{OH} , I _{OL}	High or low level output current (V _{CC} = 3.0 to 3.6V)	±24	mA
I _{OH} , I _{OL}	High or low level output current (V _{CC} = 2.7V)	±12	mA
T _{op}	Operating temperature	-40 to 85	°C
dt/dv	Input rise and fall time (2)	0 to 10	ns/V

^{1.} Truth Table guaranteed: 1.5V to 3.6V

^{2.} V_O < GND

^{2.} V_{IN} from 0.8V to 2V at $V_{CC} = 3.0V$

Electrical characteristics 74LCX04

4 Electrical characteristics

Table 5. DC specifications

		Te	est condition	Val			
Symbol	Parameter	v _{cc}		-40 to	Unit		
		(V)		Min	Max	7	
V_{IH}	High level input voltage	2.7 to 3.6		2.0		٧	
V_{IL}	Low level input voltage	2.7 10 3.0			0.8	٧	
		2.7 to 3.6	I _O =-100 μA	V _{CC} -0.2			
W	High level output	2.7	I _O =-12 mA	2.2		1	
V_{OH}	voltage	0.0	I _O =-18 mA	2.4		V	
		3.0	I _O =-24 mA	2.2			
		2.7 to 3.6	I _O =100 μA		0.2		
V	Low level output	2.7	I _O =12 mA		0.4	,,	
V_{OL}	voltage	0.0	I _O =16 mA		0.4	- V	
		3.0	I _O =24 mA		0.55		
I _I	Input leakage current	2.7 to 3.6	V _I = 0 to 5.5V		±5	μΑ	
I _{off}	Power OFF leakage current	0	$V_{\rm I}$ or $V_{\rm O} = 5.5 V$		10	μΑ	
1	Quiescent supply	0.745.0.0	$V_I = V_{CC}$ or GND		10		
I _{CC}	current	2.7 to 3.6	V_{I} or V_{O} = 3.6 to 5.5V		±10	μΑ	
ΔI_{CC}	I incr. per Input	2.7 to 3.6	V _{IH} = V _{CC} - 0.6V		500	μΑ	

Table 6. Dynamic switching characteristics

		Test condition		Value			
Symbol	Parameter	v _{cc}		T,	_λ = 25 °	Č	Unit
		(V)		Min	Тур	Max	
V _{OLP}	Dynamic low level quiet	3.3	$C_L = 50pF$ $V_{IL} = 0V, V_{IH} = 3.3V$		0.8		V
V _{OLV}	output ⁽¹⁾	3.3	$V_{IL} = 0V, V_{IH} = 3.3V$		-0.8		V

Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.

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74LCX04 Test circuit

		Test condition				Va		
Symbol	Parameter	V _{CC}	CL	R_{L}	$t_s = t_r$	-40 to	85 °C	Unit
		(V)	(pF)	(Ω)	(ns)	Min	Max	
tou tou	Propagation delay	2.7	50	500	2.5		6.0	ns
t _{PLH} t _{PHL}	time	3.0 to 3.6	50	300	2.5	1.0	5.2	115
t _{OSLH}	Output to output	0.0+0.0	50	F00	0.5		1.0	

Table 7. AC electrical characteristics

50

500

2.5

1.0

ns

3.0 to 3.6

toshl

Table 8. Capacitive characteristics

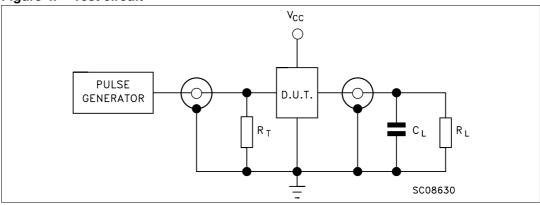
skew time (1) (2)

		Tes	Value				
Symbol	Parameter	V _{CC}		T _A = 25 °C		Unit	
		(V)		Min	Тур	Max	
C _{IN}	Input capacitance	3.3	$V_{IN} = 0$ to V_{CC}		5		pF
C _{PD}	Power dissipation capacitance (1)	3.3	$f_{IN} = 10MHz$ $V_{IN} = 0 \text{ or } V_{CC}$		41		pF

C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the
operating current consumption without load. (Refer to Test Circuit). Average operating current can be
obtained by the following equation. I_{CC(opr)} = C_{PD} x V_{CC} x f_{IN} + I_{CC}/6 (per gate)

5 Test circuit

Figure 4. Test circuit



 $C_L = 50 pF$ or equivalent (includes jig and probe capacitance)

 $R_L = 500\Omega$ or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

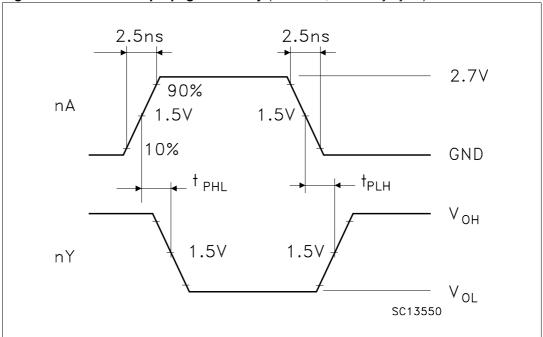
Skew is defined as the absolute value of the difference between the actual propagation delay for any two
outputs of the same device switching in the same direction, either HIGH or LOW (t_{OSLH} = | t_{PLHm} - t_{PLHn}|,
t_{OSHL} = | t_{PHLm} - t_{PHLn}|)

^{2.} Parameter guaranteed by design

Waveforms 74LCX04

6 Waveforms





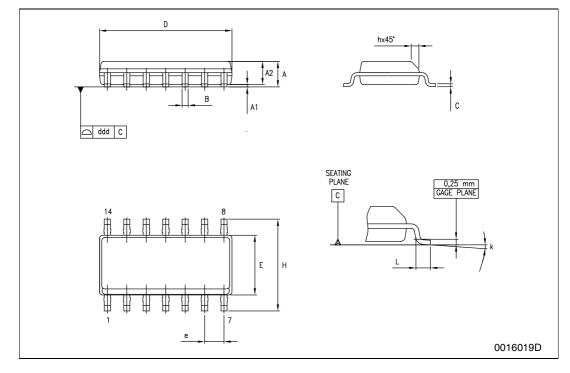
7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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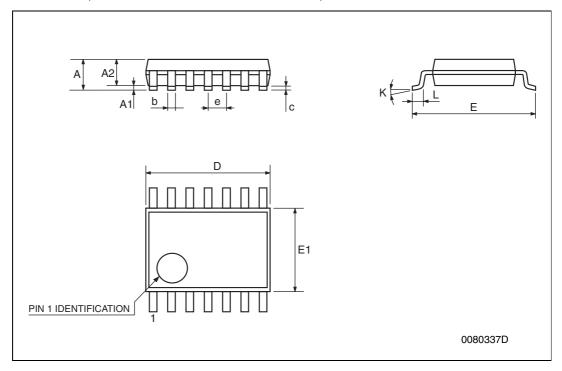
SO-1	14	MECH	ם וע	ΔΤΔ
30-	-		~	$\overline{}$

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А	1.35		1.75	0.053		0.069	
A1	0.1		0.25	0.004		0.010	
A2	1.10		1.65	0.043		0.065	
В	0.33		0.51	0.013		0.020	
С	0.19		0.25	0.007		0.010	
D	8.55		8.75	0.337		0.344	
Е	3.8		4.0	0.150		0.157	
е		1.27			0.050		
Н	5.8		6.2	0.228		0.244	
h	0.25		0.50	0.010		0.020	
L	0.4		1.27	0.016		0.050	
k	0°		8°	0°		8°	
ddd			0.100			0.004	



TSSOP14 MECHANICAL DATA

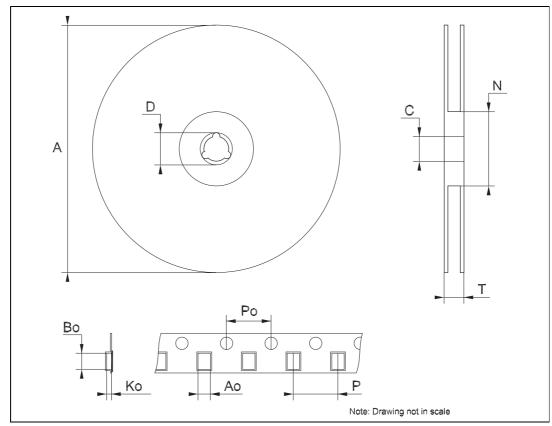
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65 BSC			0.0256 BSC	
К	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



5/

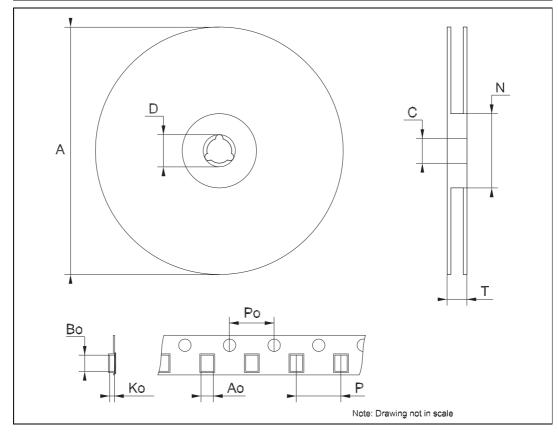
Tape &	Reel SC)-14 MECI	HANICAL	DATA
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DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			22.4			0.882
Ao	6.4		6.6	0.252		0.260
Во	9		9.2	0.354		0.362
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
Р	7.9		8.1	0.311		0.319



Tape & Reel TSSOP14 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Во	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
Р	7.9		8.1	0.311		0.319



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Revision history 74LCX04

8 Revision history

Table 9. Revision history

Date	Revision	Changes
15-Sep-2004	5	Ordering codes revision - pag. 1.
06-Jul-2006	6	New template, temperature ranges updated

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